

SPECIFICATION

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SPEC. NO.: PS-549	55-XXXXX-XXX	REVISION:	A
PRODUCT NAME:	2.00mm BATTERY	CONN. VERTICAL TYPE	
PRODUCT NO:	54955 SERIES		

APPROVED:	CHECKED:	PREPARED:
LIUJINLAN	DAVID	SIMON
DATE: 2014/1/18	DATE: 2014/1/18	DATE: 2014/1/18

ACES Aces P/N: **54955 SERIES** TITLE: 2.00mm BATTERY CONN. VERTICAL TYPE RELEASE DATE:2014/1/18 REVISION: A ECN No: 1401276 PAGE: **2** OF **9** REVISION HISTORY3 1 2 SCOPE 4 3 APPLICABLE DOCUMENTS4 4 REQUIREMENTS4 5 PERFORMANCE5 INFRARED REFLOW CONDITION......8 6 PRODUCT QUALIFICATION AND TEST SEQUENCE......9



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1 Revision History

Rev.	ECN#	Revision Description	Prepared	Date
1	ECN-1212447	NEW SPEC	XHX	2012/12/17
0	ECN-1305040	NEW SPEC RELEASE	CHENBO	2013/05/31
A	ECN-1401276	ADD Working Voltage	LIUJINLAN	2014/1/18



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2 SCOPE

This specification covers performance, tests and quality requirements for 2.00mm pitch Battery Conn. Vertical Type.

3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

- 4.1 Design and Construction
 - 4.1.1 Connector shall be of the design, construction and physical dimensions specified on the applicable sales drawing.
 - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
 - 4.2.1 Contact: High performance copper alloy

Finish: Pls. refer to the drawing.

- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.3 Board Lock: High performance copper alloy

Finish: Pls. refer to the drawing.

4.2.4 Screw: High performance copper alloy

Finish: Pls. refer to the drawing.

- 4.3 Ratings
 - 4.3.1 Working Voltage Less than 36 Volts AC (per pin)
 - 4.3.2 Voltage: 30V AC,DC (per pin)
 - 4.3.3 Current: 5.0A AC,DC (per pin)
 - 4.3.4 Operating Temperature : -40 to +85

connectors

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5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard				
	Product shall meet	Visual, dimensional and functional				
Examination of Product	requirements of applicable	per applicable quality inspection plan.				
	product drawing and specification.	ріап.				
	ELECTRICA					
Item	Requirement	Standard				
Low Level Initial: 20 m Ω Max. Contact Resistance After test: 40 m Ω Max.		Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)				
Insulation Resistance	500 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)				
Dielectric Withstanding Voltage	No breakdown.	500 V AC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)				
Temperature rise 30 Max.Change allowed		Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25 (EIA-364-70,METHOD1, CONDITION1)				
	MECHANICA	L				
Item	Requirement	Standard				
Contact Retention Force 0.4kgf Min		Operation Speed: 25.4 ± 3 mm/minute. Measure the contact retention force with Tensile strength tester.				

connectors

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Lock Retention Force	0.35kgf Min	Operation Speed: 25.4 ± 3 mm/minute. Measure the contact retention force with Tensile strength tester.		
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)		
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50G's(peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shal be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 10mA maximum for all contacts. (EIA-364-27, test Condition A)		
	ENVIRONMEN [*]	ΓAL		
Resistance to Wave Soldering Heat	See Product Qualification and Test Sequence Group 10 (Lead Free)	Solder Temp.: 265±5 , 10±0.5sec.		
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 10 (Lead Free)	Pre Heat: 150 ~180 , 60~120sec. Heat: 230 Min., 40sec Min. Peak Temp.: 260 Max, 10sec Max.		



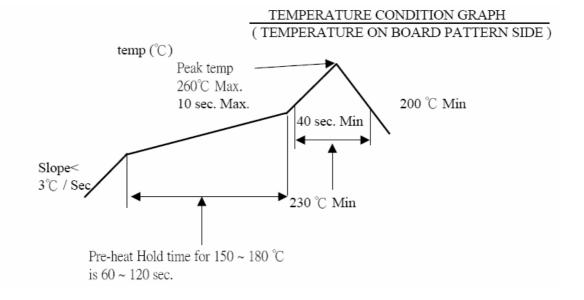
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Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55+0/-3 , 30 minutes +85 +3/-0 , 30 minutes (EIA-364-32, test condition I)
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40 , 90~95% RH, 96 hours. (EIA-364-31,Condition A, Method II)
Temperature life	See product Qualification and test sequence group5	Subject mated connectors to temperature life at 85 for 96 hours. (EIA-364-17, Test condition A)
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35 (I) Gold flash for 8 hours (II) Gold plating 5 u" for 96 hours. (EIA-364-26)
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5 , for 4-5 sec. (EIA-364-52)
Hand Soldering Temperature Resistance	Appearance: No damage	T 350 , 3sec at least.

Note. Flowing Mixed Gas shell be conduct by customer request.

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6 INFRARED REFLOW CONDITION



10	con	nec	tors	
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7 PRODUCT QUALIFICATION AND TEST SEQUENCE

	Test Group										
Test or Examination	1	2	3	4	5	6	7	8	9	10	11
					Tes	t Sequ	ience				
Examination of Product	1,3		1,7	1,6	1,4				1,4	1	
Low Level Contact Resistance		1,4	2,10	2,9	2,5				2,5		
Insulation Resistance			3,9	3,8							
Dielectric Withstanding Voltage			4,8	4,7							
Temperature rise	2										
Contact Retention Force							1				
Vibration		2									
Shock(Mechanical)		3									
Resistance to Hand Soldering Heat									3		
Thermal Shock			5								
Humidity			6								
Temperature life				5							
Salt Spray					3						
Solder ability						1					
Lock Retention Force								1			
Hand Soldering Temperature Resistance										2	
Sample Size	2	4	4	4	4	4	2	4	4	4	